

MATERIALS AND FINISHES

BODY: BRASS
PLATED NICKEL

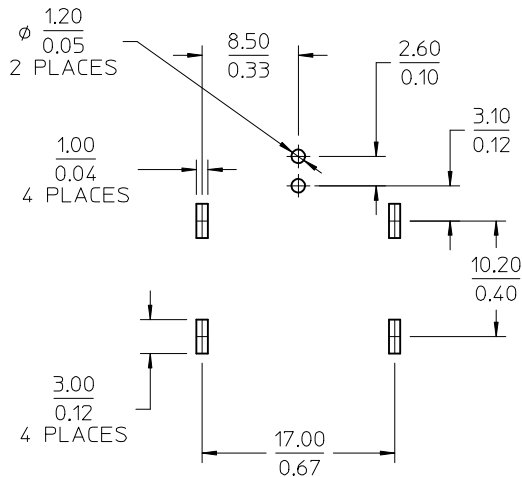
CENTER CONTACT: PHOSPHOR BRONZE
PLATED GOLD

INSULATOR: TEFLON

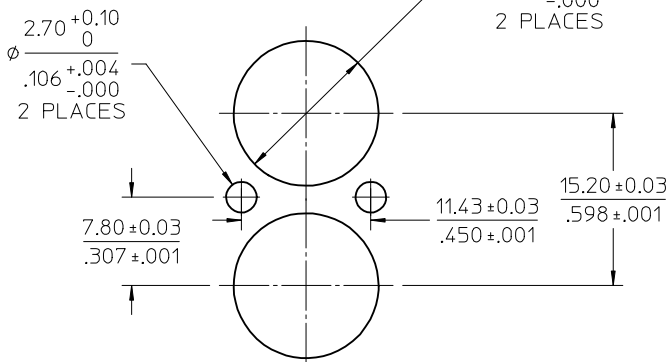
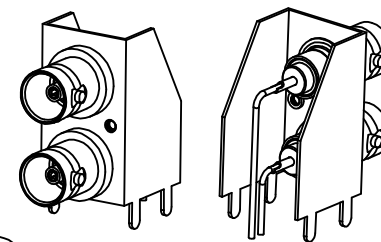
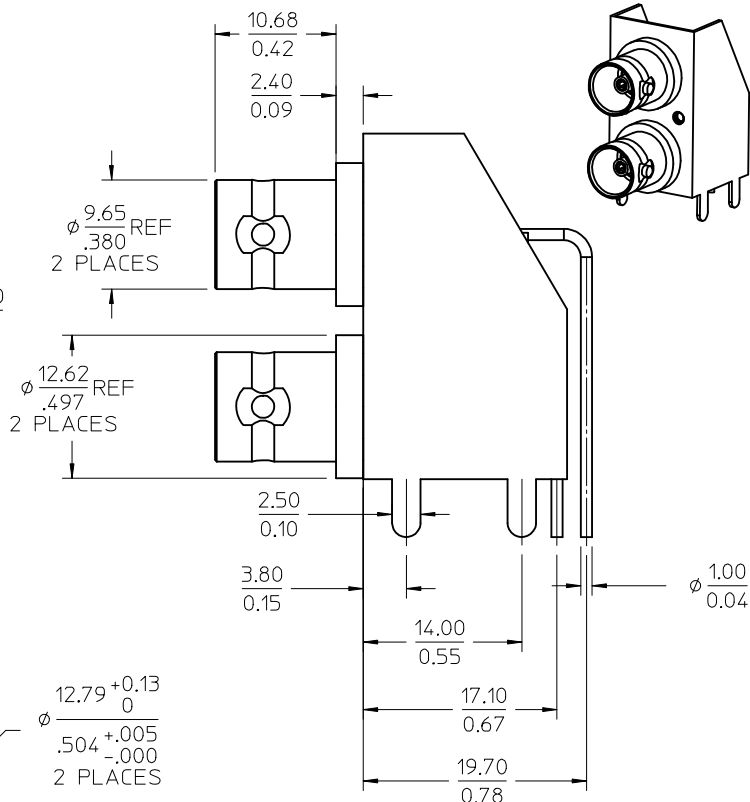
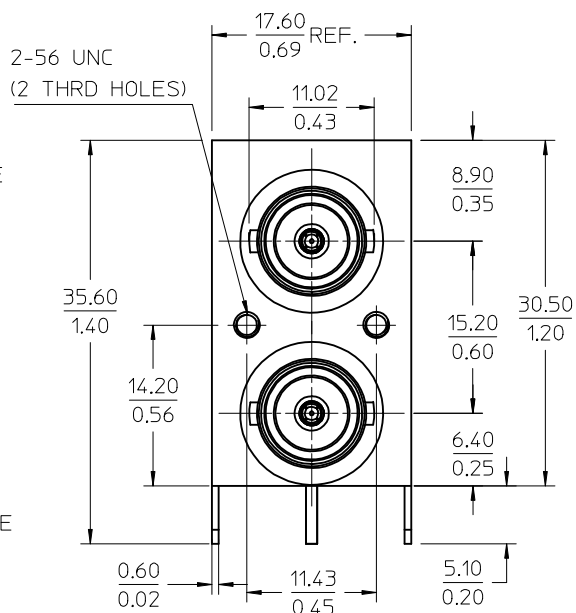
PRESS RING: STEEL
PASSIVATE

BRACKET: SPCC
PLATED NICKEL

GROUNDING: COPPER OVER STEEL WIRE
PLATED TIN



RECOMMENDED PCB LAYOUT



RECOMMENDED
PANEL CUT-OUT
PANEL THK: 2.00/0.079 MAX.

PS-73598-0051	ELEC/MECH PERFORMANCE
MIL-STD-348A, FIG. 301.2	INTERFACE
SPECIFICATION	DESCRIPTION

73415-3981	1 PC PER BAG
73415-3980	TRAY
PART NO.	PACKAGING

CHG: ADDED PANEL CUTOUT PER RF45-E253 EC NO: URF2016-0007 DRWN: CME102 CHKD: APPR: YCHENG 2015/07/09 2015/07/23	QUALITY SYMBOLS ▽=0 ▽=0 ▽=0
---	---

GENERAL TOLERANCES (UNLESS SPECIFIED)	
mm	INCH
4 PLACES ±	±
3 PLACES ±	±
2 PLACES ±	±
1 PLACE ±	±
0 PLACE ±	±
ANGULAR ± 2 °	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	

DIMENSION STYLE MM/IN	
DRAWN BY	DATE
CLL I	2003/09/08
CHECKED BY	DATE
-	2003/09/08
APPROVED BY	DATE
-	2003/09/08
MATERIAL NO.	
SEE TABLE	
SIZE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION
C	

SCALE	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
TITLE BNC 75 OHMS JACK DUAL BNC-J/PCB		
DOCUMENT NO. SD-73415-398		
SHEET NO. 1 OF 1		

molex